

PRODUCT NUMBER

73347-Y04LF

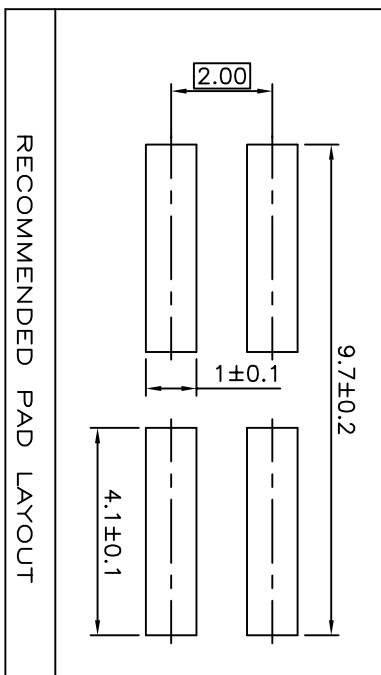
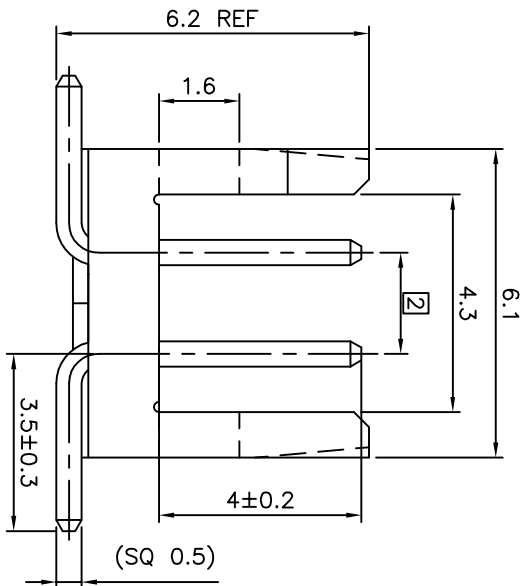
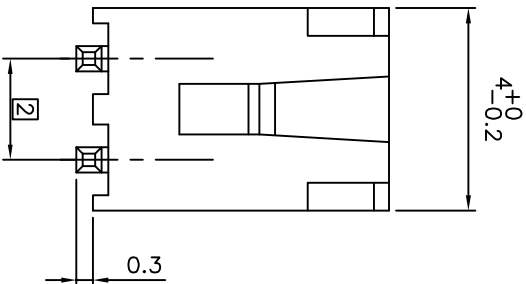
PLATING ROHS COMPATIBLE, SEE NOTE 5

1XX = 0.76µm GOLD/GXT ON CONTACT AREA
2µm MIN MATT TIN ON TAIL
7XXLF = 0.76µm GOLD/GXT FULL PLATED
OVER 1.27µm Ni MIN

1.27µm MINIMUM NICKEL UNDERPLATE

NOTES :

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
4. STANDARD PACKAGING IN POLYBAGS:
5. ROHS COMPATIBLE PRODUCT SPECIFICATIONS
- d - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.
- b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 30 SECONDS MAX IN A CONVECTION, INFRA-RED OR VAPOR PHASE OR REFLOW OVEN.
- c - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-47-0004.
6. PIN POS 1 RECOMMENDED ON THIS SIDE TO MATCH WITH HOUSING CODING.



NOTE 6

Form A3 1 2 3 4 5 6

mat'l. code	SEE NOTES	surface	tolerance	projection	product
ecm no	dr date	ISO 1302	ISO 406	mm	family
B-19190	LMU 14.10.24	tolerances unless otherwise specified	ISO 1125	mm	MINITEK HEADER
E F06-0268	LMU 06.08.09	linear	97.11.25	scale 6:1	MINITEK
F F07-0191	JCO 07.09.05	JCOMPAGNON	97.11.25		HEADER 2x2
G F08-0143	EIA 15.04.08	engr			sheet 1 of 1
H F11-0078	LMU 11.06.29	chr			size A3
J F12-0018	JCO 12.02.27	qppd	JMC	98.03.20	CUSTOMER Drawing
sheet	revision				
index	sheet				